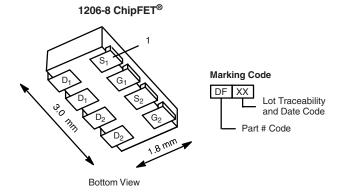




Dual P-Channel 1.8 V (G-S) MOSFET

PRODUCT SUMMARY				
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A)		
- 20	0.086 at V _{GS} = - 4.5 V	- 4.1		
	0.121 at V _{GS} = - 2.5 V	- 3.4		
	0.171 at V _{GS} = - 1.8 V	- 2.9		



Ordering Information: Si5935DC-T1-E3 (Lead (Pb)-free)

Si5935DC-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

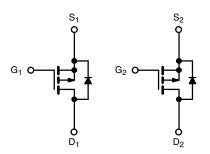
- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET[®] Power MOSFETs
- Low R_{DS(on)} Dual and Excellent Power Handling in a Compact Footprint
- Compliant to RoHS Directive 2002/95/EC



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Load Switch
- PA Switch
- Battery Switch



P-Channel MOSFET

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted							
Parameter		Symbol	5 s	5 s Steady State			
Drain-Source Voltage		V_{DS}	- 20		V		
Gate-Source Voltage		V_{GS}	± 8				
Continuous Drain Current (T _{.I} = 150 °C) ^a	T _A = 25 °C	- I _D	- 4.1	- 3	Α		
Continuous Diain Current (1 _J = 150 °C)	T _A = 85 °C		- 2.9	- 2.2			
Pulsed Drain Current		I _{DM}	- 15				
Continuous Source Current (Diode Conduction) ^a		I _S	- 1.8	- 0.9			
Maximum Power Dissipation ^a	T _A = 25 °C	P _D	2.1	1.1	W		
Waximum Fower Dissipation	T _A = 85 °C		1.1	0.6			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150		°C		
Soldering Recommendations (Peak Temperature) ^{b, c}			260		C		

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Marian na lunation to Ambianta	t ≤ 5 s	- R _{thJA}	50	60	°C/W
Maximum Junction-to-Ambient ^a	Steady State		90	110	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	30	40	

Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. See reliability manual for profile. The ChipFET is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- c. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.

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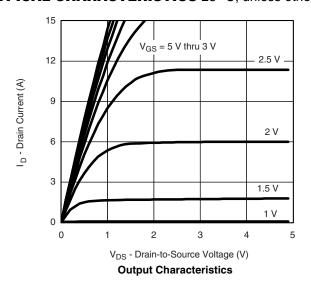
SPECIFICATIONS T _J = 25 °C, unless otherwise noted								
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit		
Static								
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \mu A$	- 0.4		- 1.0	V		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 20 V, V _{GS} = 0 V			- 1	μΑ		
		$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 ^{\circ}\text{C}$			- 5			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 15			Α		
		V _{GS} = - 4.5 V, I _D = - 3 A		0.069	0.086	Ω		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 2.5 V, I _D = - 2.5 A		0.097	0.121			
		V _{GS} = - 1.8 V, I _D = - 0.6 A		0.137	0.171			
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 3 A		8		S		
Diode Forward Voltage ^a	V_{SD}	I _S = - 0.9 A, V _{GS} = 0 V		- 0.8	- 1.2	V		
Dynamic ^b								
Total Gate Charge	Q_g			5.5	8.5			
Gate-Source Charge	Q_{gs} $V_{DS} = -10 \text{ V}, V_{GS} = -4.5 \text{ V}, I_D = -3 \text{ A}$		0.91		nC			
Gate-Drain Charge	Q_{gd}			1.6				
Turn-On Delay Time	t _{d(on)}			18	30			
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_{L} = 10 \Omega$		32	50	ns		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -1$ A, $V_{GEN} = -4.5$ V, $R_g = 6$ Ω		42	65			
Fall Time	t _f			26	40			
Source-Drain Reverse Recovery Time	t _{rr}	I _F = - 0.9 A, dI/dt = 100 A/μs		30	60			

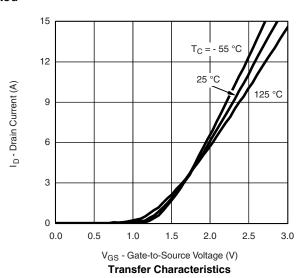
Notes:

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

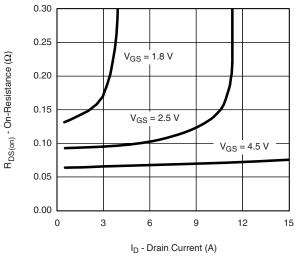




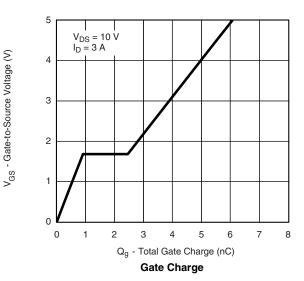




TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

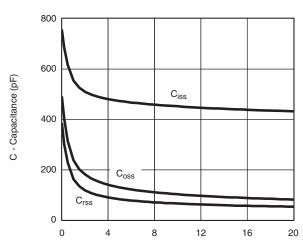


On-Resistance vs. Drain Current

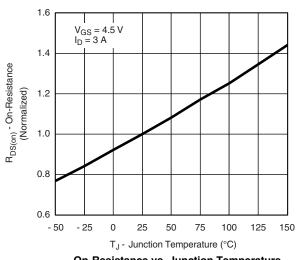


20 10 $T_J = 25$ °C $T_J = 150 \, ^{\circ}\text{C}$ 0.0 0.2 0.4 0.6 0.8 1.0 1.2 1.4 V_{SD} - Source-to-Drain Voltage (V)

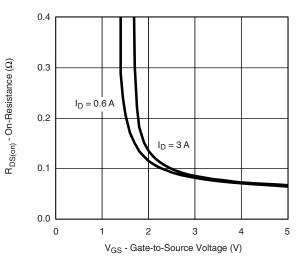
Source-Drain Diode Forward Voltage



V_{DS} - Drain-to-Source Voltage (V) Capacitance



On-Resistance vs. Junction Temperature



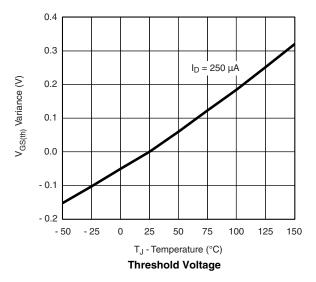
On-Resistance vs. Gate-to-Source Voltage

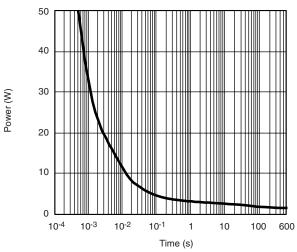
Is - Source Current (A)

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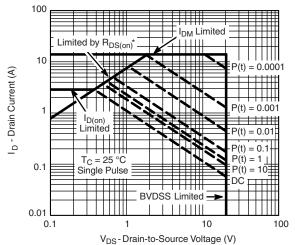
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

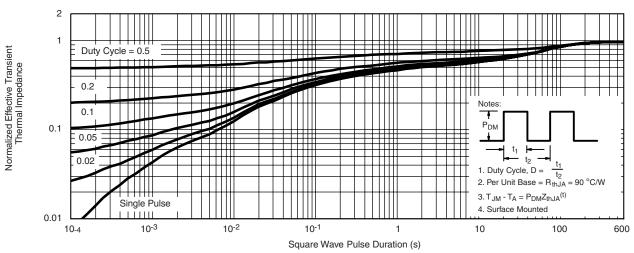




Single Pulse Power



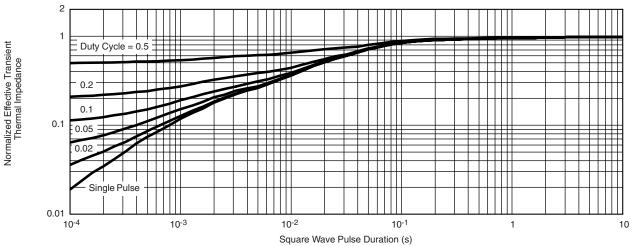
* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified Safe Operating Area



Normalized Thermal Transient Impedance, Junction-to-Ambient



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg272220.



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